

KEY FEATURES

- AdvancedTCA standard form factor
- PICMG 3.1 compliant
- Module has provision for putting different mass type to simulate a real environment
- Provision to allow event detector to monitor the backplane and the RTM

The ATC000 was designed for shock and vibration testing. The module accommodates for putting different mass type distribution across the ATCA Module to simulate real systems requirement while testing the ATCA Chassis.

The module has provision that routes the signals from the backplane to the front for event detectors. The event detectors could be connected via the front panel during shock/vibration per each connector.

VadaTech can modify this product to meet special customer requirements without NRE (minimum order placement is required).

AdvancedTCA®

ATCA Module for Shock and Vibration Testing

SPECIFICATIONS

Architecture		
Physical	Dimensions	Width: 12.687in. (322.25 mm)
		Depth: 11.024 in. (280 mm)
Type	Shock/Vibration	Different mass type
Standards		
PICMG	ATCA	PICMG 3.0 R2.0
Module Management	IPMI	None
Configuration		
Power	ATC000	0W
Environmental	Temperature	Operating Temperature: -45° to 95° C
		Storage Temperature: -55° to +95° C
Other		
MTBF	MIL Handbook 217-F > 1,000,000 Hrs.	
Certifications	Designed to meet FCC, CE and UL certifications where applicable	
Standards	VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards	
Compliance	RoHS and NEBS	
Warranty	Two (2) years.	
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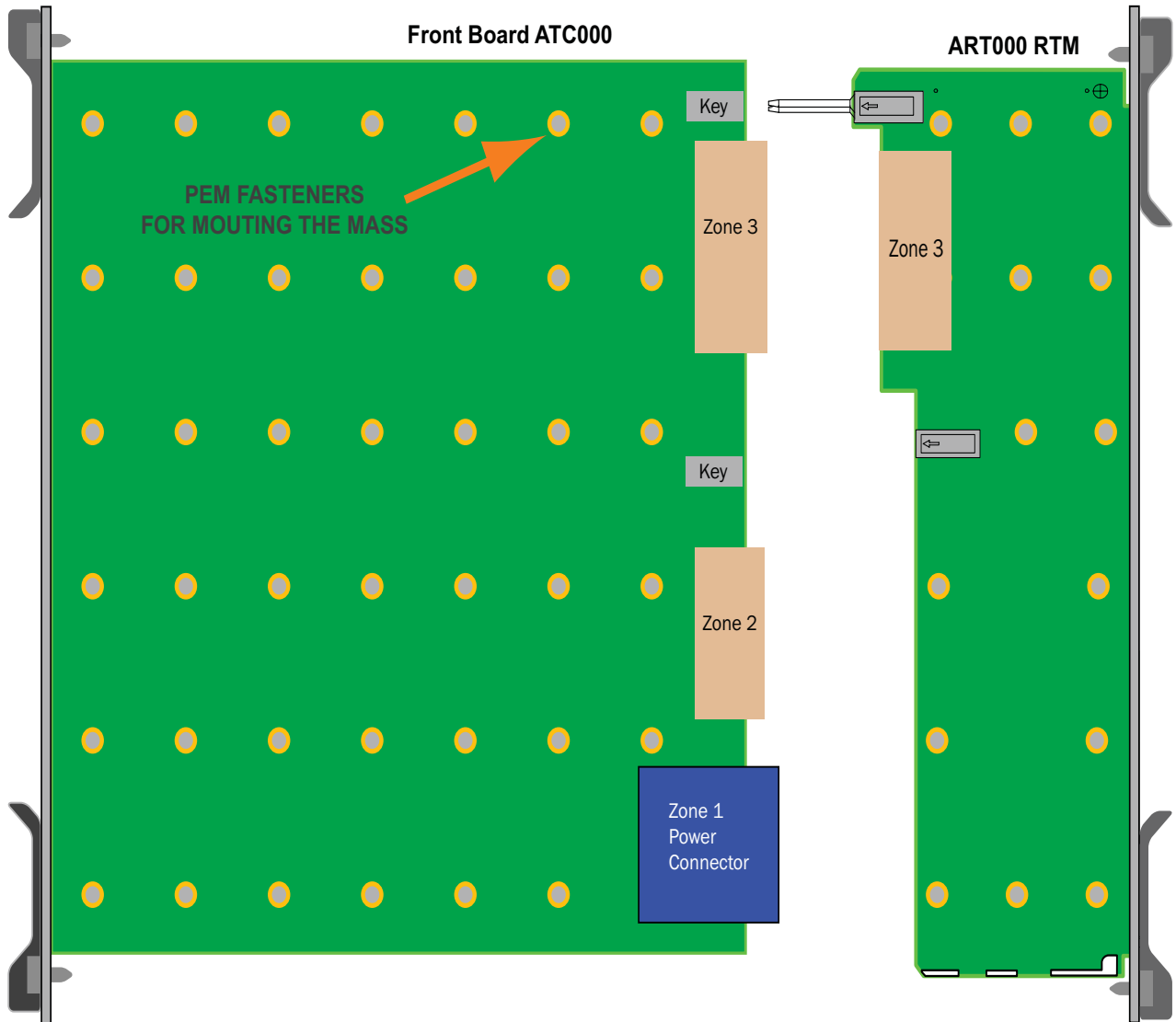


FIGURE 1. ATC000 Functional Block Diagram

ORDERING OPTIONS

ATC000 - 000- 000 - 00J

J = Conformal Coating

- 0 = None
- 1 = Humiseal 1A33 Polyurethane
- 2 = Humiseal 1B31 Acrylic

